

### The Most **Reliable** Memory For Industries



### **Industrial DRAM Solutions**

www.apacer.com

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### What Sets Apacer Apart?

### **Professional Technique**

- Strong HW/FW engineering know-how
- Customized design with a variety of solutions
- State-of-the-art technology

### **Quality Assurance**

100% reliable & compliant
Wide temperature test
Thermal shock test
Strict ORT (Ongoing Reliability Test)
Power cycle test
Humidity test
Altitude test
Reliability test (Vibration/Shock)

### **Extensive Experience**

- Tier 1 industrial SSD & memory supplier; delivered over 377 million units
- Comprehensive experience in product customization (across industries)

### **Reliable Service**

- Fixed BOM solution
- Longevity of supply, EOL & LTB notice
- Manufacturing in Taiwan protects IP

### **Trustworthy Supplier**

- A global-scale service and maintenance system
- Responsive local FAE technical support
- 24/7 flexible and quick delivery service
- Complete RMA system

### Temperature

Wide Temperature Dust/ Moisture

Conformal Coating

Shock/ Vibration

Underfill XR-DIMM Rugged SODIMM

### Corrosion

Anti-Sulfuration (patented)

### Solutions for Extreme Environments

Nowadays, as industrial memory products have been widely used in various kinds of applications, the need for memory modules that can maintain highly stable operating performance in harsh conditions is remarkably increasing.

As an industrial solution veteran and leading memory brand, Apacer always takes an outside-in perspective and strives for new breakthroughs, providing many value-added solutions and technologies for extreme environments to ensure product reliability, stability and durability.

### Technologies and Advantages





Apacer's patented anti-sulfuration memory modules replace standard silver electrodes with an exclusive alloy which has passed the ASTM B809-95 anti-sulfuration test.

- World's first anti-sulfuration memory modules
- Solve corrosion problems effectively and increase overall system lifespan

### Anti-sulfuration test



### Anti-sulfuration technology comparison



Underfill

Apacer provides underfill technology to increase product reliability and resistance to various thermal and mechanical shocks, ensuring that products continue to operate normally in high vibration and under extreme changes in environmental temperature.





Especially designed for harsh climates and special environmental conditions.

- Operating temperature range: -40 °C ≤ TC ≤ 85°C
- All industrial-grade components (DRAM, PCB, resistors and capacitors) ensure stability and reliability
- High/Low temp. test / Temp. cycling test
- Power cycling test

### Insists on using industrial-grade DRAM ICs



### Apacer's strengths of wide temperature memory

Apacer industrial-grade wide temp. memory		Standard memory (Commercial)
Industrial-grade (-40 ~ +85°C) Suitable for extreme high and low temperature environment	< DRAM >	Commercial-grade (0 ~ +85°C)
<b>30μ"</b> Avoids gold finger oxidation and ensures the stability of signal transmission	PCB plating thickness	3 <i>µ"</i>
Up to +125°C Ensures more stable voltage supply in high-temperature environment	Capacitor temp. specification	+85°C
<b>± 1% tolerance</b> Increases circuit stability and durability	Resistor specification	$\pm$ 5% tolerance





With the  $30\mu$  gold plating, the connector interface is more reliable and can withstand the potential damages in industrial applications.



Enhances reliability of products by applying coatings on the surface of printed circuit boards. The protective film can safeguard devices from dust ingression and liquid immersion.

- Uses automated spraying to maintain precise coating thickness
- Enhances product reliability
- Prolongs DRAM modules' lifespan



• Apacer DRAM module with conformal coating



### Extremely Rugged XR-DIMM

- Innovative board-to-board connector design
- Adopts highly durable 300-pin connector and mounting holes to improve the anti-vibration and anti-shock reliability
- Dual anti-shock and vibration certification: RTCA DO-160G / MIL-STD-810G
- Supports multiple protection technologies and value-added applications

### Rugged Memory Comparison

	XR-DIMM Rugged Memory	Onboard memory
Anti-shock & anti-vibration ability	Great	Great
Memory upgradability	Yes	No
Repair difficulty	Easy	Difficult
RMA cost	Low	High
Stackable design	Yes	No
Motherboard space usage	Flexible	Uniform and inflexible

### Supports multiple value-added applications





### UDIMM (Unbuffered DIMM)

- JEDEC-compliant design
- Applicable for desktop computers, industrial computers and embedded systems

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Model	DDR5 UDIMM	DDR4 UDIMM	DDR3 UDIMM	DDR2 UDIMM	DDR UDIMM
Module Type	UDIMM	UDIMM	UDIMM	UDIMM	UDIMM
Memory Technology	DDR5	DDR4	DDR3	DDR2	DDR
Frequency	4800/5600	2133/2400/2666 2933/3200	1066/1333/1600/1866	533/667/800	266/333/400
Density	8GB/16GB/32GB	2GB/4GB/8GB/ 16GB/32GB	1GB/2GB/4GB/ 8GB/16GB	1GB/2GB/4GB	512MB/1GB
Voltage	1.1v	1.2v	1.5v/1.35v	1.8v	2.5v/2.6v
Pin Count	288-Pin	288-Pin	240-Pin	240-Pin	184-Pin
Width	64-Bit	64-Bit	64-Bit	64-Bit	64-Bit
PCB Height	1.23"	1.23"	1.18"	1.18"	1.25"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TA=0℃ to 70℃
Application		Gaming /	Healthcare / IoT / Factory A	utomation	
				Underfill	Conformal Coeffic

#### SODIMM (Small Outline DIMM)

- JEDEC-compliant design
- Applicable for space-constraint systems, such as notebook computers, small-size industrial computers and embedded systems

			92 H 32		
Model	DDR5 SODIMM	DDR4 SODIMM	DDR3 SODIMM	DDR2 SODIMM	DDR SODIMM
Module Type	SODIMM	SODIMM	SODIMM	SODIMM	SODIMM
Memory Technology	DDR5	DDR4	DDR3	DDR2	DDR
Frequency	4800/5600	2133/2400/2666 2933/3200	1066/1333/1600/1866	533/667/800	266/333/400
Density	8GB/16GB/32GB	2GB/4GB/ 8GB/16GB/32GB	1GB/2GB/4GB/ 8GB/16GB	1GB/2GB/4GB	512MB/1GB
Voltage	1.1v	1.2v	1.5v/1.35v	1.8v	2.5v/2.6v
Pin Count	262-Pin	260-Pin	204-Pin	200-Pin	200-Pin
Width	64-Bit	64-Bit	64-Bit	64-Bit	64-Bit
PCB Height	1.18"	1.18"	1.18"	1.18"	1.25"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TA=0°C to 70°C
Application		Gaming / Ic	oT / Transportation / Factory	Automation	
	Underfill				

### Server/Workstation

#### RDIMM (ECC Registered DIMM)

- Includes a register to enhance clock, command and control signals
- $\cdot$  Supports ECC error detection and correction
- Supports a built-in temperature-monitoring thermal sensor
- Applicable for enterprise servers and cloud data centers

	anout hours	( 000 Parents )	
Model	DDR5 RDIMM	DDR4 RDIMM	DDR3 RDIMM
Module Type	RDIMM	RDIMM	RDIMM
Memory Technology	DDR5	DDR4	DDR3
Frequency	4800/5600	2133/2400/2666/2933/3200	1066/1333/1600/1866
Density	16GB/32GB/64GB/128GB	4GB/8GB/16GB/ 32GB/64GB/128GB	4GB/8GB
Voltage	1.1v	1.2v	1.5v/1.35v
Pin Count	288-Pin	288-Pin	240-Pin
Width	80-Bit	72-Bit	72-Bit
PCB Height	1.23"	1.23"	1.18"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃
Application		Healthcare / Server & Networking	



#### LRDIMM (Load Reduced DIMM)

- Includes a register to enhance clock, command and control signals
- Enhanced data signal with placing data buffer
- Supports ECC error detection and correction
- Supports a built-in temperature-monitoring thermal sensor
- Applicable for enterprise servers and cloud data centers

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Model	DDR4 LRDIMM	
Module Type	LRDIMM	
Memory Technology	DDR4	
Frequency	2666/2933/3200	
Density	64GB/128GB	
Voltage	1.2v	
Pin Count	288-Pin	
Width	72-Bit	
PCB Height	1.23"	
Operation Temperature	TC=0℃ to 85℃	
Application	Healthcare / Server & Networking	



### Server/Workstation

### ECC UDIMM (ECC Unbuffered DIMM)

- $\cdot$  Supports ECC error detection and correction
- Supports a built-in temperature-monitoring thermal sensor
- Applicable for servers and workstations that require highly stable operation

		00000	55668	No. 12 March 19
Model	DDR5 ECC UDIMM	DDR4 ECC UDIMM	DDR3 ECC UDIMM	DDR2 ECC UDIMM
Module Type	ECC UDIMM	ECC UDIMM	ECC UDIMM	ECC UDIMM
Memory Technology	DDR5	DDR4	DDR3	DDR2
Frequency	4800/5600	2133/2400/2666/2933/3200	1066/1333/1600/1866	533/667/800
Density	16GB/32GB	4GB/8GB/16GB/32GB	2GB/4GB/8GB/16GB	1GB/2GB/4GB
Voltage	1.1v	1.2v	1.5v/1.35v	1.8v
Pin Count	288-Pin	288-Pin	240-Pin	240-Pin
Width	72-Bit	72-Bit	72-Bit	72-Bit
PCB Height	1.23"	1.23"	1.18"	1.18"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃
Application	Healthcare / IoT / Server & Netwoking / Factory Automation			
Value-Added	BOUND Startinger	Jerensel Brenser Bernser	Terminal Senter Senter	30µ Gald Finger

### ECC SODIMM (ECC Small Outline DIMM)

- Supports ECC error detection and correction
- Supports a built-in temperature-monitoring thermal sensor
- Applicable for microservers, workstations, networking platforms and embedded systems

			E B C
Model	DDR5 ECC SODIMM	DDR4 ECC SODIMM	DDR3 ECC SODIMM
Module Type	ECC SODIMM	ECC SODIMM	ECC SODIMM
Memory Technology	DDR5	DDR4	DDR3
Frequency	4800/5600	2133/2400/2666/2933/3200	1066/1333/1600/1866
Density	16GB/32GB	4GB/8GB/16GB/32GB	2GB/4GB/8GB/16GB
Voltage	1.1v	1.2v	1.5v/1.35v
Pin Count	262-Pin	260-Pin	204-Pin
Width	72-Bit	72-Bit	72-Bit
PCB Height	1.18"	1.18"	1.18"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃
Application	IoT / Serv	ver & Networking / Transportation / Factory Au	tomation
Value-Added	Binner Tierren Bede Finger Underfill	Beneral Boot Frager	30µ Gold Finger Underfill

### Server/Workstation

### SORDIMM (Small Outline ECC Registered DIMM)

- · Achieves signal synchronization and stability with the use of a register
- Supports ECC error detection and correction
- Supports a built-in temperature-monitoring thermal sensor
- · Applicable for small-sized microserver and networking equipment, such as switches and routers

Model	DDR4 SORDIMM	
Module Type	(VLP) SORDIMM	
Memory Technology	DDR4	
Frequency	2133/2400/2666	
Density	4GB/8GB/16GB	
Voltage	1.2v	
Pin Count	260-Pin	
Width	72-Bit	
PCB Height	0.738"/1.18"	
Operation Temperature	TC=0℃ to 85℃	
Application	Server & Networking	

Value-Added



CE

#### VLP Mini RDIMM / VLP Mini ECC UDIMM

- Supports a built-in temperature-monitoring thermal sensor
- High capacity, high performance and high stability
- $\cdot$  Supports ECC error detection and correction
- Measures only 80mm long
- · Applicable for space-constrained networking, communication, server and embedded system

Model	DDR4 Mini RDIMM	DDR4 VLP Mini ECC UDIMM	
Module Type	(VLP) Mini RDIMM	VLP Mini ECC UDIMM	
Memory Technology	DDR4	DDR4	
Frequency	2133/2400/2666	2133/2400/2666	
Density	4GB/8GB/16GB	4GB/8GB/16GB	
Voltage	1.2v	1.2v	
Pin Count	288-Pin	288-Pin	
Width	72-Bit	72-Bit	
PCB Height	0.738"/1.23″	0.738"	
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	
Application	Server & Networking	Server & Networking	
Value-Added	BOUL Thermal Sensor	Termini Bontor Codel Proger	

### Very Low Profile

#### VLP UDIMM (Very Low Profile Unbuffered DIMM)

- Measures only 0.72~0.738-inch in height
- Prevents mechanical issues, and improves heat dissipation
- Applicable for space-constrained systems, such as small-size industrial computers and embedded systems

Model	DDR5 VLP UDIMM	DDR4 VLP UDIMM	
Module Type	VLP UDIMM	VLP UDIMM	
Memory Technology	DDR5	DDR4	
Frequency	4800/5600	2133/2400/2666/2933/3200	
Density	16GB/32GB	4GB/8GB/16GB/32GB	
Voltage	1.1v	1.2v	
Pin Count	288-Pin	288-Pin	
Width	64-Bit	64-Bit	
PCB Height	0.738"	0.738"	
Operation Temperature	TC=0°C to 85°C	TC=0℃ to 85℃	
Application	loT / Server & Networking		

Value-Added





#### VLP SODIMM (Very Low Profile SODIMM) / VLP ECC SODIMM (Very Low Profile ECC SODIMM)

- Measures only 0.7~0.709-inch in height
- Saves up to 40% board space
- · Applicable for space-constrained systems, such as small form-factor industrial computers and embedded systems

Model	DDR4 VLP SODIMM	DDR4 VLP ECC SODIMM
Module Type	VLP SODIMM	VLP ECC SODIMM
Memory Technology	DDR4	DDR4
Frequency	2133/2400/2666/2933/3200	2133/2400/2666/2933/3200
Density	4GB/8GB	4GB/8GB
Voltage	1.2V	1.2V
Pin Count	260-Pin	260-Pin
Width	64-Bit	72-Bit
PCB Height	0.709"	0.7"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃
Application	loT / Trar	isportation

Value-Added





### Very Low Profile

### VLP RDIMM (Very Low Profile Registered DIMM)

- Measures only 0.738-inch in height
- Prevents mechanical issues, and improves heat dissipation
- Supports ECC error detection and correction
- Supports a built-in temperature-monitoring thermal sensor
- · Applicable for space-constrained systems and systems that require high stability, such as blade servers, 1U rack servers and various embedded systems.

Model	DDR4 VLP RDIMM	DDR3 VLP RDIMM
Module Type	VLP RDIMM	VLP RDIMM
Memory Technology	DDR4	DDR3
Frequency	2133/2400/2666/2933/3200	1066/1333/1600
Density	4GB/8GB/16GB/32GB	4GB/8GB
Voltage	1.2v	1.5v/1.35v
Pin Count	288-Pin	240-Pin
Width	72-Bit	72-Bit
PCB Height	0.738"	0.738"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃
Application	Healthcare / Server & Networking	
Value-Added	Thermal Benarries BOUL	Benor Thermol Sensor Bala Finger Cold Finger Underfill

#### VLP ECC UDIMM (Very Low Profile ECC Unbuffered DIMM)

- Measures only 0.738-inch in height
- Prevents mechanical issues, and improves heat dissipation
- Supports ECC error detection and correction
- Supports a built-in temperature-monitoring thermal sensor
- Applicable for space-constrained, servers and workstations that require high stability

			<b>800007</b> ==-9
Model	DDR5 VLP ECC UDIMM	DDR4 VLP ECC UDIMM	DDR3 VLP ECC UDIMM
Module Type	VLP ECC UDIMM	VLP ECC UDIMM	VLP ECC UDIMM
Memory Technology	DDR5	DDR4	DDR3
Frequency	4800/5600	2133/2400/2666/2933/3200	1066/1333/1600
Density	16GB/32GB	4GB/8GB/16GB/32GB	2GB/4GB/8GB
Voltage	1.1v	1.2v	1.5v/1.35v
Pin Count	288-Pin	288-Pin	240-Pin
Width	72-Bit	72-Bit	72-Bit
PCB Height	0.738"	0.738"	0.738"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃
Application		Healthcare / Server & Networking	
Value-Added			Barrow Ba

### Wide Temperature

### Wide Temp. UDIMM (Wide Temperature UDIMM)

- $\cdot$  Able to operate in temperatures ranging from -40  $^\circ C$  to 85  $^\circ C$
- Uses industrial-grade SDRAM components
- With 30u gold plating PCB to improve anti-oxidation and ensure stability of signal transmission
- Applicable for industrial, defense, aeronautical and vehicular systems that face extreme environmental challenges

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Model	DDR5 Wide Temp. UDIMM	DDR4 Wide Temp. UDIMM	DDR3 Wide Temp. UDIMM
Module Type	Wide Temperature UDIMM	Wide Temperature UDIMM	Wide Temperature UDIMM
Memory Technology	DDR5	DDR4	DDR3
Frequency	4800/5600	2133/2400/2666/2933/3200	1066/1333/1600
Density	8GB/16GB/32GB	4GB/8GB/16GB/32GB	2GB/4GB/8GB
Voltage	1.1v	1.2v	1.5v/1.35v
Pin Count	288-Pin	288-Pin	240-Pin
Width	64-Bit	64-Bit	64-Bit
PCB Height	1.23"	1.23"	1.18"
Operation Temperature	TC=-40℃ to 85℃	TC=-40℃ to 85℃	TC=-40℃ to 85℃
Application	Def	ense / IoT / Transportation / Factory Automa	ation



#### Wide Temp. SODIMM (Wide Temperature SODIMM)

- $\cdot$  Able to operate in temperatures ranging from -40  $^\circ C$  to 85  $^\circ C$
- Uses industrial-grade SDRAM components
- With 30u gold plating PCB to improve anti-oxidation and ensure stability of signal transmission
- · Applicable for industrial, defense, aeronautical and vehicular systems that face extreme environmental challenges

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		THE REAL PROPERTY OF			SAMA ANA
Model	DDR5 Wide Temp. SODIMM	DDR4 Wide Temp. SODIMM	DDR3 Wide Temp. SODIMM	DDR2 Wide Temp. SODIMM	DDR Wide Temp. SODIMM
Module Type	Wide Temperature SODIMM	Wide Temperature SODIMM	Wide Temperature SODIMM	Wide Temperature SODIMM	Wide Temperature SODIMM
Memory Technology	DDR5	DDR4	DDR3	DDR2	DDR
Frequency	4800/5600	2133/2400/2666/ 2933/3200	1066/1333/1600	533/667/800	266/333/400
Density	8GB/16GB/32GB	4GB/8GB/16GB/32GB	2GB/4GB/8GB	1GB/2GB	512MB/1GB
Voltage	1.1v	1.2v	1.5v/1.35v	1.8v	2.5v/2.6v
Pin Count	262-Pin	260-Pin	204-Pin	200-Pin	200-Pin
Width	64-Bit	64-Bit	64-Bit	64-Bit	64-Bit
PCB Height	1.18"	1.18"	1.18"	1.18"	1.25"
Operation Temperature	TC=-40℃ to 85℃	TC=-40°C to 85°C	TC=-40℃ to 85℃	TC=-40℃ to 85℃	TA=-40°C to 85°C
Application		Defense / IoT	/ Transportation / Factory	Automation	
Value-Added	Understand		Unterel	Uther Web Temperature Uthertit Uthertit Uthertit	Understa Temperatura Temperatura

### Wide Temperature

### Wide Temp. ECC UDIMM (Wide Temperature ECC UDIMM)

- $\cdot$  Able to operate in temperatures ranging from -40  $^\circ\!C$  to 85  $^\circ\!C$
- Uses industrial-grade SDRAM components
- With 30u gold plating PCB to improve anti-oxidation and ensure stability of signal transmission
- · Applicable for industrial, defense, aeronautical and vehicular systems that face extreme environmental challenges

	AND	00000 -/	
Model	DDR5 Wide Temp. ECC UDIMM	DDR4 Wide Temp. ECC UDIMM	DDR3 Wide Temp. ECC UDIMM
Module Type	Wide Temperature ECC UDIMM	Wide Temperature ECC UDIMM	Wide Temperature ECC UDIMM
Memory Technology	DDR5	DDR4	DDR3
Frequency	4800/5600	2133/2400/2666/2933/3200	1066/1333/1600
Density	16GB/32GB	4GB/8GB/16GB/32GB	2GB/4GB/8GB
Voltage	1.1v	1.2v	1.5v/1.35v
Pin Count	288-Pin	288-Pin	240-Pin
Width	72-Bit	72-Bit	72-Bit
PCB Height	1.23"	1.23"	1.18"
Operation Temperature	TC=-40°C to 85°C	TC=-40℃ to 85℃	TC=-40°C to 85°C
Application	Defens	se / IoT / Transportation / Factory Auto	mation

Value-Added







#### Wide Temp. ECC SODIMM (Wide Temperature ECC SODIMM)

- Able to operate in temperatures ranging from -40°C to 85°C
- Uses industrial-grade SDRAM components
- With 30u gold plating PCB to improve anti-oxidation and ensure stability of signal transmission
- · Applicable for industrial, defense, aeronautical and vehicular systems that face extreme environmental challenges

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Model	DDR5 Wide Temp. ECC SODIMM	DDR4 Wide Temp. ECC SODIMM	DDR3 Wide Temp. ECC SODIMM
Module Type	Wide Temperature ECC SODIMM	Wide Temperature ECC SODIMM	Wide Temperature ECC SODIMM
Memory Technology	DDR5	DDR4	DDR3
Frequency	4800/5600	2133/2400/2666/2933/3200	1066/1333/1600
Density	16GB/32GB	4GB/8GB/16GB/32GB	2GB/4GB/8GB
Voltage	1.1v	1.2v	1.5v/1.35v
Pin Count	262-Pin	260-Pin	204-Pin
Width	72-Bit	72-Bit	72-Bit
PCB Height	1.18"	1.18"	1.18"
Operation Temperature	TC=-40℃ to 85℃	TC=-40℃ to 85℃	TC=-40°C to 85°C
Application	Defens	se / IoT / Transportation / Factory Auto	mation







### Anti-Sulfuration (Apacer Patented)

### **Anti-Sulfuration Memory Modules**

- $\cdot$  World's first anti-sulfuration memory modules for the sulfur-containing environment
- The innovative design is now patented

· Applicable for equipment exposed in highly contaminated environment and electronic equipment used in areas of high-concentration sulfur gas

	1911111 × 101-14	0000		4000
Model	DDR5 Anti-Sulfuration UDIMM	DDR4 Anti-Sulfuration UDIMM	DDR5 Anti-Sulfuration SODIMM	DDR4 Anti-Sulfuration SODIMM
Module Type	Anti-Sulfuration UDIMM	Anti-Sulfuration UDIMM	Anti-Sulfuration SODIMM	Anti-Sulfuration SODIMM
Memory Technology	DDR5	DDR4	DDR5	DDR4
Frequency	4800/5600	2133/2400/2666/2933/3200	4800/5600	2133/2400/2666/2933/3200
Density	8GB/16GB/32GB	4GB/8GB/16GB/32GB	8GB/16GB/32GB	4GB/8GB/16GB/32GB
Voltage	1.1v	1.2v	1.1v	1.2v
Pin Count	288-Pin	288-Pin	262-Pin	260-Pin
Width	64-Bit	64-Bit	64-Bit	64-Bit
PCB Height	1.23"	1.23"	1.18"	1.18"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃ / -40℃ to 85℃
Application		Defense / Healthcare / IoT / Trans	sportation / Factory Automation	
			30µ	

	noonitioone	( 1000 <u>- 1</u> 00000)		00000 7		- 411-11-155
Model	DDR5 Anti-Sulfuration RDIMM	DDR4 Anti-Sulfuration RDIMM	DDR5 Anti-Sulfuration ECC UDIMM	DDR4 Anti-Sulfuration ECC UDIMM	DDR5 Anti-Sulfuration ECC SODIMM	DDR4 Anti-Sulfuration ECC SODIMM
Module Type	Anti-Sulfuration RDIMM	Anti-Sulfuration RDIMM	Anti-Sulfuration ECC UDIMM	Anti-Sulfuration ECC UDIMM	Anti-Sulfuration ECC SODIMM	Anti-Sulfuration ECC SODIMM
Memory Technology	DDR5	DDR4	DDR5	DDR4	DDR5	DDR4
Frequency	4800/5600	2133/2400/2666/ 2933/3200	4800/5600	2133/2400/2666/ 2933/3200	4800/5600	2133/2400/2666/ 2933/3200
Density	16GB/32GB	4GB/8GB/ 16GB/32GB	16GB/32GB	4GB/8GB/ 16GB/32GB	16GB/32GB	4GB/8GB/ 16GB/32GB
Voltage	1.1v	1.2v	1.1v	1.2v	1.1v	1.2v
Pin Count	288-Pin	288-Pin	288-Pin	288-Pin	262-Pin	260-Pin
Width	80-Bit	72-Bit	72-Bit	72-Bit	72-Bit	72-Bit
PCB Height	1.23"	1.23"	1.23"	1.23"	1.18"	1.18"
Operation Temperature	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃
Application		Defense /	′ Healthcare / IoT / Trar	sportation / Factory A	utomation	
Value-Added	Thermal Sensor Gold Finger	Thermal Bensor	Thermal Bencor	Thermal Sensor	Thermal Gold Finger	Thermal Gold Finger

# Rugged Memory

#### **Rugged SODIMM**

- Designed with two mounting holes to secure the memory module to the board to achieve shock and vibration resistance
- Dual anti-shock and vibration certification: RTCA DO-160G / MIL-STD-883K
- Applicable for transportation, automation, wind power geneation, energy, defense and aeronautical equipment that requires shock and vibration resistance



Model	DDR4 Rugged SODIMM	
Module Type	Rugged SODIMM	
Memory Technology	DDR4	
Frequency	2133/2400/2666/2933/3200	
Density	8GB/16GB/32GB	
Voltage	1.2v	
Pin Count	260-Pin	
Width	64-Bit/72-Bit	
PCB Height	1.377"	
Operation Temperature	TC=0°C to 85°C / -40°C to 85°C	
Application	Defense / Transportation	

Value-Added



#### **XR-DIMM**

- Designed for shock and vibration environments
- Innovative design with highly rugged 300-pin connector and mounting holes
- Dual anti-shock and vibration certification: RTCA DO-160G / MIL-STD-810G
- Improves the stability of signal transmission
- · Applicable for transportation, defense and aeronautical equipment that requires shock and vibration resistance

Model	DDR4 XR-DIMM	
Module Type	XR-DIMM	
Memory Technology	DDR4	
Frequency	2133/2400	
Density	8GB/16GB	
Voltage	1.2v	
Pin Count	300-Pin	
Width	72-Bit	
PCB Height	1.466"	
Operation Temperature	TC=−40°C to 85°C	
Application	Defense / Transportation	



## Fully Lead-Free

### Fully Lead-Free Memory Module

- The world's first Fully Lead-Free memory module, surpassing RoHS environmental standards.
- Fully compliant with RoHS standards, no RoHS exemptions required
- Uses Fully Lead-Free Resistors without RoHS 7(c)-I exemption
- Meeting the market demand for environmentally friendly products

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Model	DDR5 Fully Lead-free UDIMM	DDR5 Fully Lead-free SODIMM	DDR5 Fully Lead-free RDIMM	DDR5 Fully Lead-free ECC UDIMM	DDR5 Fully Lead-free ECC SODIMM
Module Type	Fully Lead-free UDIMM	Fully Lead-free SODIMM	Fully Lead-free RDIMM	Fully Lead-free ECC UDIMM	Fully Lead-free ECC SODIMM
Memory Technology	DDR5	DDR5	DDR5	DDR5	DDR5
Frequency	4800/5600	4800/5600	4800	4800/5600	4800/5600
Density	8GB/16GB/32GB	8GB/16GB/32GB	16GB/32GB	16GB/32GB	16GB/32GB
Voltage	1.1v	1.1v	1.1v	1.1v	1.1v
Pin Count	288-Pin	262-Pin	288-Pin	288-Pin	262-Pin
Width	64-Bit	64-Bit	80-Bit	72-Bit	72-Bit
PCB Height	1.23"	1.18"	1.23"	1.23"	1.18"
Operating Temperature	TC=0℃ to 85℃	TC=0°C to 85°C	TC=0℃ to 85℃	TC=0℃ to 85℃	TC=0℃ to 85℃
Application	Gaming / Healthcare / IoT / Factory Automation	Gaming / IoT / Transportation / Factory Automation	Healthcare / Server & Networking	Healthcare / IoT / Server & Netwoking / Factory Automation	loT / Server & Networking / Transportation / Factory Automation
Value-Added		Land Line Contention and Line Contention			

About Apacer

Apacer

Apacer is a global leader in digital storage solutions, and is devoted to innovative storage technology and services. After more than 25 years in the industry, we remain dedicated to " Becoming Better Partners. " Our core values, as always, continue to revolve around reliability and innovation.

The company focuses on embedded applications for a variety of vertical markets, including military, medical, gaming, and industrial, and has become an integration expert in digital storage, innovative applications, and value-added services. Apacer is known for its advanced technologies and product quality and was ranked by Gartner as the top industrial SSD supplier for five consecutive years, from 2012 to 2016. In addition, Apacer is committed to making a positive impact on societal issues and has joined the Responsible Business Alliance (RBA), which is formerly known as Electronic Industry Citizenship Coalition (EICC), a coalition promoting ESG (Environmental, Social, Governance) within the global electronics supply chain. We believe that the success of a corporation is marked not by profit but by how we benefit others, whether by caring for the environment or making contributions to society.

#### Compliance and Associations *JEDEC S* 原本 () 第 RoHS () RoHS () 第 RoHS () 7 ROHS ()

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### The Most Reliable Memory For Industries



### **Global Presence**

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